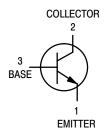
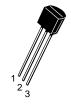
High Current Transistors

NPN Silicon



http://onsemi.com





TO-92 (TO-226AA) CASE 29 STYLE 14

ORDERING INFORMATION

Device	Package	Shipping
BC635RL1	TO-92	2000/Tape & Reel
BC635ZL1	TO-92	2000/Ammo Pack
BC637	TO-92	5000 Units/Box
BC639	TO-92	5000 Units/Box
BC639RL1	TO-92	2000/Tape & Reel
BC639ZL1	TO-92	2000/Ammo Pack
BC639-16ZL1	TO-92	2000/Ammo Pack

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage BC635 BC637 BC639	VCEO	45 60 80	Vdc
Collector-Base Voltage BC635 BC637 BC639	VCBO	45 60 80	Vdc
Emitter-Base Voltage	V _{EBO}	5.0	Vdc
Collector Current — Continuous	IC	1.0	Adc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	PD	625 5.0	mW mW/°C
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	800 12	mW mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	–55 to +150	°C

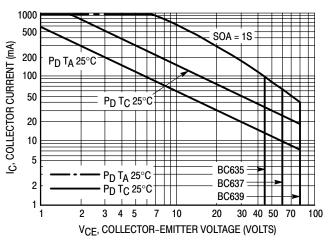
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	200	°C/W
Thermal Resistance, Junction to Case	R _θ JC	83.3	°C/W

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						•
Collector–Emitter Breakdown Voltage (1) (IC = 10 μ Adc, IB = 0)	BC635 BC637 BC639	V(BR)CEO	45 60 80	_ _ _	_ _ _	Vdc
Collector–Emitter Zero–Gate Breakdown Voltage (1 $(I_C = 100 \mu Adc, I_B = 0)$) BC639–16	V(BR)CES	120	_	_	Vdc
Collector–Base Breakdown Voltage (I _C = 100 μAdc, I _E = 0)	BC635 BC637 BC639	V(BR)CBO	45 60 80	_ _ _	_ _ _	Vdc
Emitter–Base Breakdown Voltage (IE = 10 μ Adc, IC = 0)		V(BR)EBO	5.0	_	_	Vdc
Collector Cutoff Current (V _{CB} = 30 Vdc, I _E = 0) (V _{CB} = 30 Vdc, I _E = 0, T _A = 125°C)		ICBO	_ _	_ _	100 10	nAdc μAdc
ON CHARACTERISTICS (1)						
DC Current Gain (I _C = 5.0 mAdc, V_{CE} = 2.0 Vdc) (I _C = 150 mAdc, V_{CE} = 2.0 Vdc) (I _C = 500 mA, V_{CE} = 2.0 V)	BC635 BC637 BC639 BC639–16ZLT1	hFE	25 40 40 40 100 25	_ _ _ _ _		_
Collector–Emitter Saturation Voltage (IC = 500 mAdc, IB = 50 mAdc)		VCE(sat)	_	_	0.5	Vdc
Base–Emitter On Voltage (I _C = 500 mAdc, V _{CE} = 2.0 Vdc)		V _{BE(on)}	_	_	1.0	Vdc
DYNAMIC CHARACTERISTICS		•		-		•
Current–Gain — Bandwidth Product (I _C = 50 mAdc, V _{CE} = 2.0 Vdc, f = 100 MHz)		fΤ	_	200	_	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 1.0 MHz)		C _{ob}	_	7.0	_	pF
Input Capacitance (VEB = 0.5 Vdc, I _C = 0, f = 1.0 MHz)		C _{ib}	_	50	_	pF

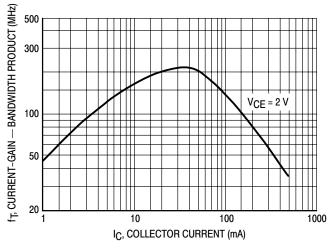
^{1.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle 2.0%.



VCE = 2 V 100 20 1 3 5 10 30 50 100 300 500 1000 IC, COLLECTOR CURRENT (mA)

Figure 1. Active Region Safe Operating Area

Figure 2. DC Current Gain



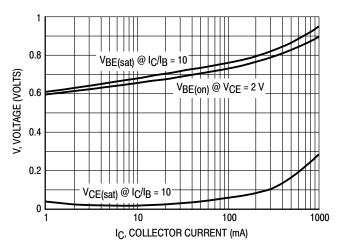


Figure 3. Current-Gain — Bandwidth Product

Figure 4. "Saturation" and "On" Voltages

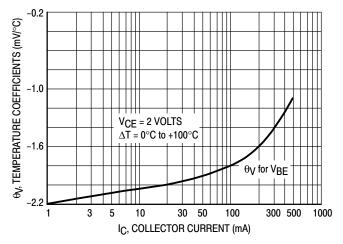
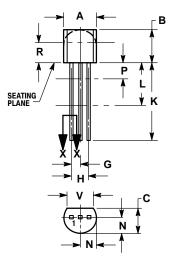


Figure 5. Temperature Coefficients

PACKAGE DIMENSIONS

TO-92 (TO-226)CASE 29-11 **ISSUE AL**





NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
 CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	METERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
J	0.015	0.020	0.39	0.50	
K	0.500		12.70		
L	0.250		6.35		
N	0.080	0.105	2.04	2.66	
P		0.100		2.54	
R	0.115		2.93		
V	0 135		3 //3		

STYLE 14:

PIN 1. EMITTER

COLLECTOR

3. BASE

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